BYW96D THRU BYW96E

SINTERED GLASS JUNCTION FAST SWITCHING PLASTIC RECTIFIER VOLTAGE:800 TO 1000V CURRENT: 3.0A

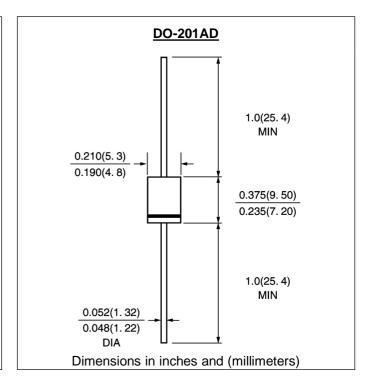




High temperature metallurgic ally bonded construction Sintered glass cavity free junction Capability of meeting environmental standard of MIL-S-19500 High temperature soldering guaranteed 350° C /10sec/0.375"lead length at 5 lbs tension Operate at Ta =55°C with no thermal run away Typical Ir<0.1µA

MECHANICAL DATA

Terminal: Plated axial leads solderable per MIL-STD 202E, method 208C Case: Molded with UL-94 Class V-0 recognized Flame Retardant Epoxy Polarity: color band denotes cathode Mounting position: any



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half-wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated)

	SYMBOL	BYW96D	BYW96E	units
Maximum Recurrent Peak Reverse Voltage	Vrrm	800	1000	V
Maximum RMS Voltage	Vrms	560	700	V
Maximum DC blocking Voltage	Vdc	800	1000	V
Reverse avalanche breakdown voltage at IR = 0.1 mA	V(BR)R (min)	900	1100	V
Maximum Average Forward Rectified Current 3/8"lead length at Ta =55°C	lf(av)	3.0		A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	lfsm	70		A
Maximum Forward Voltage at rated Forward Current and 25°C	Vf	1.50		V
Non-repetitive peak reverse avalanche energy (Note 1)	Ersm	10		mJ
Maximum DC Reverse Current Ta =25°C	Ir	5.0		μA
at rated DC blocking voltage Ta =150°C		150		μA
Maximum Reverse Recovery Time (Note 2)	Trr	300		nS
Typical Junction Capacitance (Note 3)	Cj	60		pF
Typical Thermal Resistance (Note 4)	R(ja)	16		°C /\
Storage and Operating Junction Temperature	Tstg, Tj	-65 to +175		°C

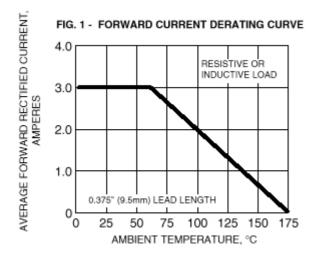
Note: 1.R=400mA; Tj=Tjmax prior to surge; inductive load switched off

2.Reverse Recovery Condition If =0.5A, Ir =1.0A, Irr =0.25A

3.Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc

4. Thermal Resistance from Junction to Ambient at 3/8" lead length, P.C. Board Mounted

RATINGS AND CHARACTERISTIC CURVES BYW96D THRU BYW96E



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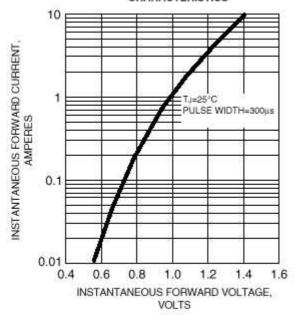
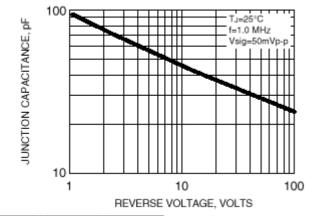


FIG. 5 - TYPICAL JUNCTION CAPACITANCE



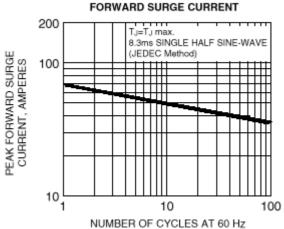


FIG. 2 - MAXIMUM NON-REPETITIVE PEAK

FIG. 4 - TYPICAL REVERSE CHARACTERISTIC

